Taiwan Semiconductor

6A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- High surge current capability
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber

MECHANICAL DATA

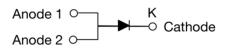
- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.107g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE			
I _F	6	А		
V _{RRM}	200 - 1000	V		
I _{FSM}	140	А		
T _{J MAX}	150 °C			
Package	TO-277A (SMPC4.6U)			
Configuration	Single die			





TO-277A (SMPC4.6U)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	TUAS 6DH	TUAS 6GH	TUAS 6JH	TUAS 6KH	TUAS 6MH	UNIT
Marking code on the dev	/ice		AS6D	AS6G	AS6J	AS6K	AS6M	
Repetitive peak reverse	voltage	V _{RRM}	200	400	600	800	1000	V
Reverse voltage, total m	ns value	V _{R(RMS)}	140	280	420	560	700	V
Forward current		١ _F	6				Α	
Surge peak forward current single half sine-					140			- A
wave superimposed on rated load	t = 1.0ms	I _{FSM}			300			A
Junction temperature T _J		T_{J}	-55 to +150				°C	
Storage temperature		T _{STG}	-55 to +150		°C			



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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	ТҮР	UNIT		
Junction-to-lead thermal resistance	R _{ƏJL}	5	°C/W		
Junction-to-ambient thermal resistance	R _{ƏJA}	45	°C/W		
Junction-to-case thermal resistance	R _{ejc}	7.9	°C/W		

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾		$I_F = 3A, T_J = 25^{\circ}C$		0.91	-	V
		$I_F = 6A, T_J = 25^{\circ}C$	N	0.98	1.10	V
		I _F = 3A, T _J = 125°C	– V _F	0.80	-	V
		$I_F = 6A, T_J = 125^{\circ}C$		0.88	-	V
Reverse current @ rated $V_R^{(2)}$		$T_J = 25^{\circ}C$		-	5	μA
		T _J = 125°C	– I _R	13	-	μA
Junction capacitance	TUAS6DH TUAS6GH TUAS6JH	1MHz, V _R = 4.0V	CJ	43	-	pF
	TUAS6KH TUAS6MH		Ŭ	39	-	

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
TUAS6xH	TO-277A (SMPC4.6U)	6,000 / Tape & Reel	

Notes:

1. "x" define voltage from 200V(TUAS6DH) to 1000V(TUAS6MH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

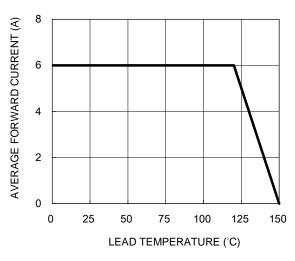
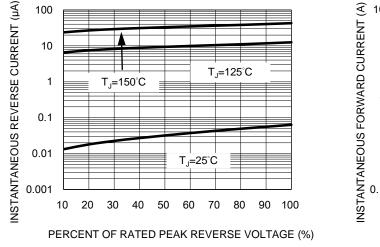


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics



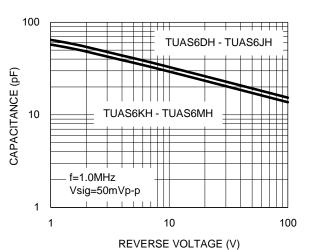
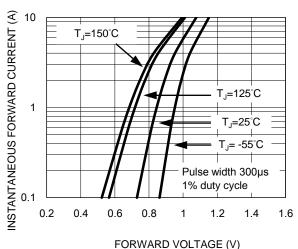


Fig.2 Typical Junction Capacitance





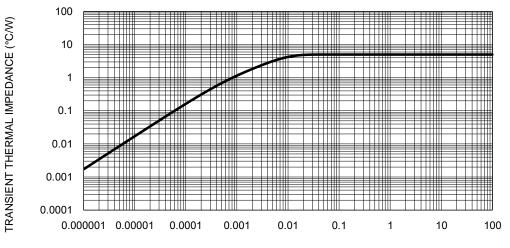


Fig.5 Typical Transient Thermal Impedance

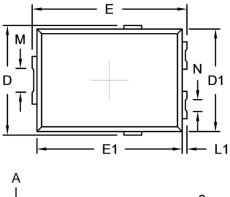
PULSE DURATION (s)

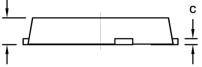
TUAS6DH – TUAS6MH Taiwan Semiconductor

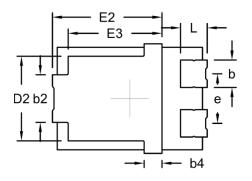


PACKAGE OUTLINE DIMENSIONS

TO-277A (SMPC4.6U)







SUGGESTED PAD LAYOUT

В

D

F

1

С

4

	DIM. Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (NOM.)	0.030	(NOM.)
с	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)	0.155 (NOM.)	
е	2.08 (NOM.)		0.082 (NOM.)	
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
М	0.65	1.15	0.026	0.045
N	0.25	0.75	0.010	0.030

Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

Symbol	Unit (mm)	Unit (inch)
A	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

Notes:

A

I

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

MARKING DIAGRAM



Е

P/N = Marking Code YW = Date Code F = Factory Code



TUAS6DH – TUAS6MH

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